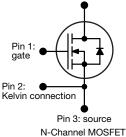
**Vishay Siliconix** 



## **E Series Power MOSFET**





PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.117			
Q <sub>g</sub> max. (nC)	116				
Q <sub>gs</sub> (nC)	18				
Q <sub>gd</sub> (nC)	33				
Configuration	Single				

#### Pin 4: drain

### FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH26N60E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V <sub>DS</sub>	600	v			
Gate-source voltage	V <sub>GS</sub>	± 30	v			
Continuous drain xurrent (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	Ι <sub>D</sub>	25			
	$V_{GS}$ at 10 V $T_C = 100 \text{ °C}$		16	A		
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	50				
Linear derating factor		1.6	W/°C			
Single pulse avalanche energy <sup>b</sup>	E <sub>AS</sub>	353	mJ			
Maximum power dissipation	PD	202	W			
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 125 °C	dV/dt	37	V/ns		
Reverse diode dV/dt <sup>c</sup>		uv/ut	20	v/115		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5 A

c.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C

1 For technical questions, contact: <u>hvm@vishay.com</u>





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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	38		50 0.62					
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.48				°C/W			
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherwi	se noted)							
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static		1						L	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	0 V, I <sub>D</sub> = 2	250 μA	600	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.67	-	V/°C	
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 µA	2	-	4	V	
	• •	١	$I_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>	١	$I_{GS} = \pm 30$	V	-	-	± 1	μA	
		V <sub>DS</sub> =	600 V, V <sub>G</sub>	<sub>5</sub> = 0 V	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	, T <sub>J</sub> = 125 °C	-	-	50	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	١ <sub>c</sub>	<sub>0</sub> = 13 A	-	0.117	0.135	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 30 V, I <sub>D</sub> =	= 13 A	-	8.6	-	S	
Dynamic						1			
Input Capacitance	C <sub>iss</sub>		$V_{ee} = 0.V$		-	2815	-		
Output Capacitance	C <sub>oss</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	125	-	1	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	7	-			
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	124	-	pF		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	381	-			
Total Gate Charge	Qg				-	77	116		
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 13 /	A, V <sub>DS</sub> = 480 V	-	18	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>				-	33	-		
Turn-On Delay Time	t <sub>d(on)</sub>				-	28	56		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub> =	= 13 A,	-	54	81		
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	10 V, R <sub>g</sub> =	9.1 Ω	-	80	120	ns	
Fall Time	t <sub>f</sub>				-	45	90		
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.2	0.5	1.1	Ω		
Drain-Source Body Diode Characteristic						•			
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	25			
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	50	A		
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 13 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V		
Reverse Recovery Time	t <sub>rr</sub>			10.4	-	459	918	ns	
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, $I_F = I_S = 13 \text{ A}$ , dl/dt = 100 A/µs, $V_B = 25 \text{ V}$		-	7.6	15.2	μC		
Reverse Recovery Current	I <sub>RRM</sub>	a, at -		n - <b>LV I</b>	-	28	-	Α	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

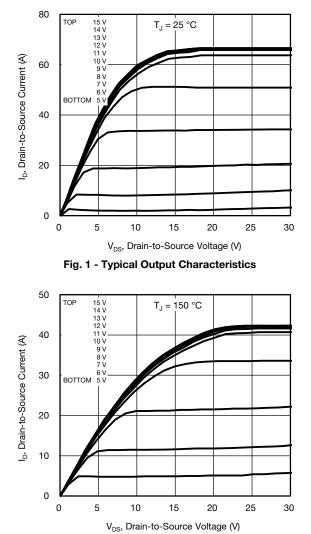
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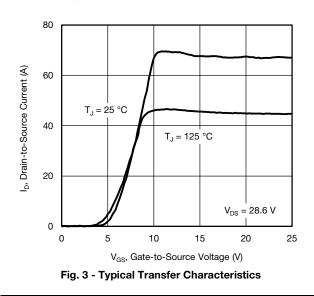


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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







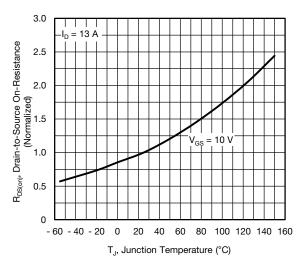


Fig. 4 - Normalized On-Resistance vs. Temperature

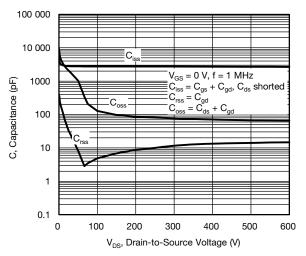


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

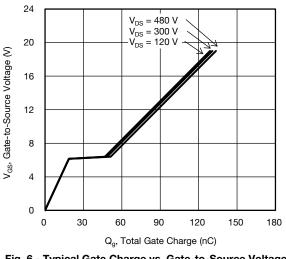


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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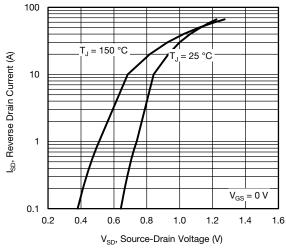
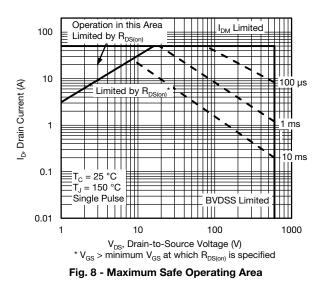


Fig. 7 - Typical Source-Drain Diode Forward Voltage



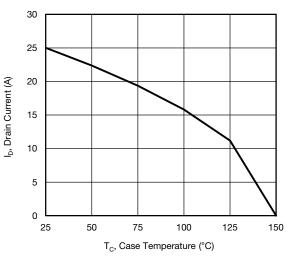
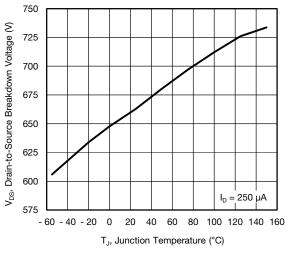
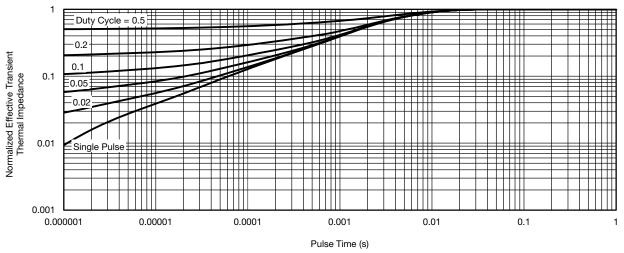


Fig. 9 - Maximum Drain Current vs. Case Temperature







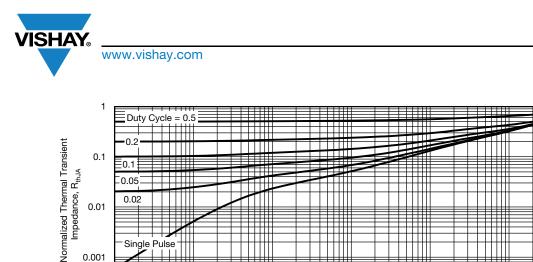


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Single Pulse 0.001 ТП Π Π 0.0001 0.0001 0.001 0.01 0.1 10 100 1000 1

Pulse Time (s)

Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Ambient

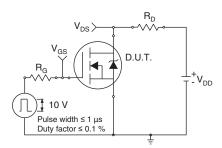


Fig. 13 - Switching Time Test Circuit

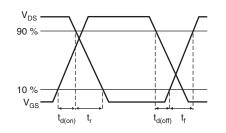


Fig. 14 - Switching Time Waveforms

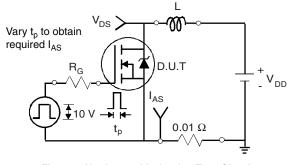
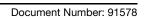
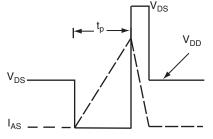


Fig. 15 - Unclamped Inductive Test Circuit

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SiHH26N60E

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Fig. 16 - Unclamped Inductive Waveforms

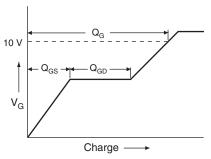
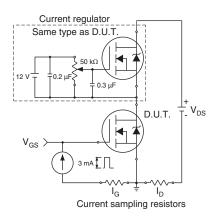


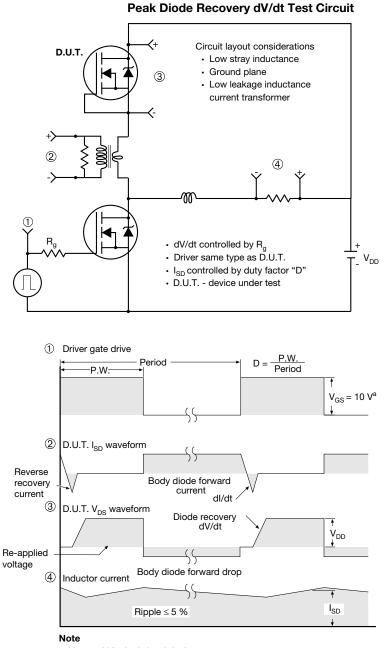
Fig. 17 - Basic Gate Charge Waveform





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#### Fig. 18 - Gate Charge Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

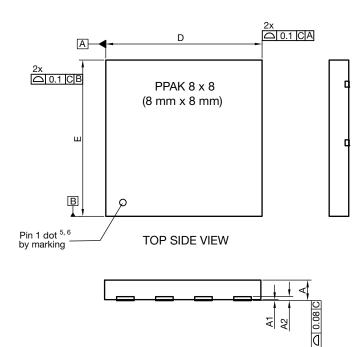
Fig. 19 - For N-Channel

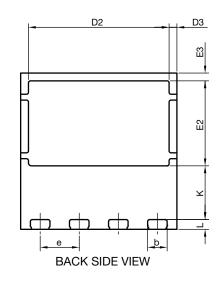
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC		0.016 BSC		<b>I</b>	
е		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N <sup>(3)</sup>	8			8			

### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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